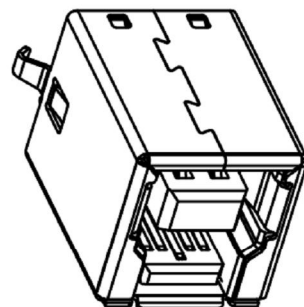
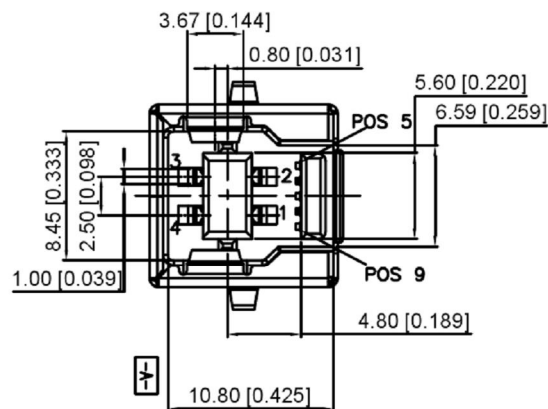


XB-SUB-110H-30L

1: Au 1U" MIN
2: Au 15U" MIN
3: Au 30U" MIN

1: WITH
2: WITHOUT

B: BLACK
U: BLUE
W: WHITE
C: CREAM-COLOR

1: PBT
2: PA9T
3: LCP
4: PA6T

SPECIFICATIONS:

Contact current Rating:

1.8 Amperes for pin1&pin4.

0.25 Amperes other contacts

Dielectric Withstanding Voltage: AC 100V(RMS)

Insulation resistance: 100Megohms Minimum.

Contact Resistance:

30mΩ Max for pin1&pin4

50mΩ Max for other contacts

Mechanical Characteristics:

Mating Force: 35 Newtons. Maximum

Unmating Force: 10 Newtons. Minimum.

8N Min After Durability

MATERIAL:

Housing: PA9T 94V-0 COLOR: SEE TABLE

Contact: copper alloy(T=0.25mm)

copper alloy(T=0.30mm)

PLATING:

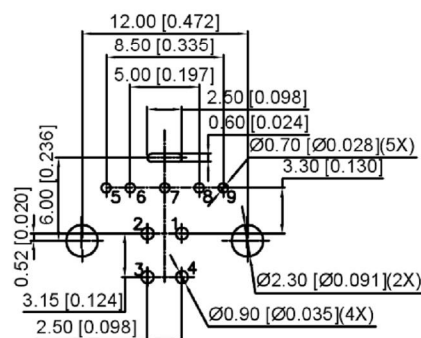
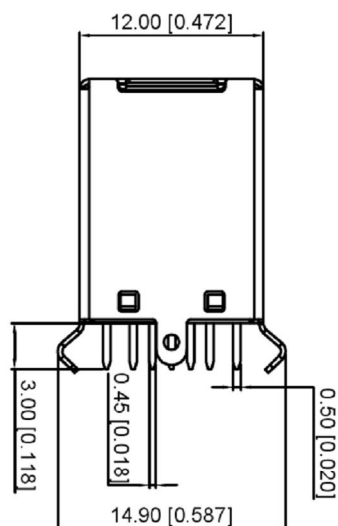
Contact: Au Plated on contact area

Tin Plated on solder area

Nickel underplating over all

Shell: Nickel Plated

operating Temperature: -55°to+85°



REFERENCE PCB LAYOUT

				ANGULAR	±5°
				L ≤ 4	±0.2
				4 < L ≤ 16	±0.3
				16 < L ≤ 63	±0.4
				L > 63	±0.5
REVISIONS				UNSPECIFIED TOLERANCES	
www.alpsr.com www.gdxjdz.com www.xbswitch.com					



DONG GUAN XI BANG ELECTRONIC CO., LTD

DSND		SCALE: N/A	MODEL TYPE: USB 3.0
DWN		VIEW:	PART NO.: XB-SUB-110H-30L
CHKD		UNIT: mm/in	DWG NO.:
APPD		SIZE: A4	
			WEIGHT
			SHEET 1/1
			REVISION A0